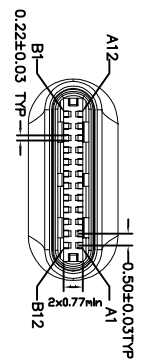
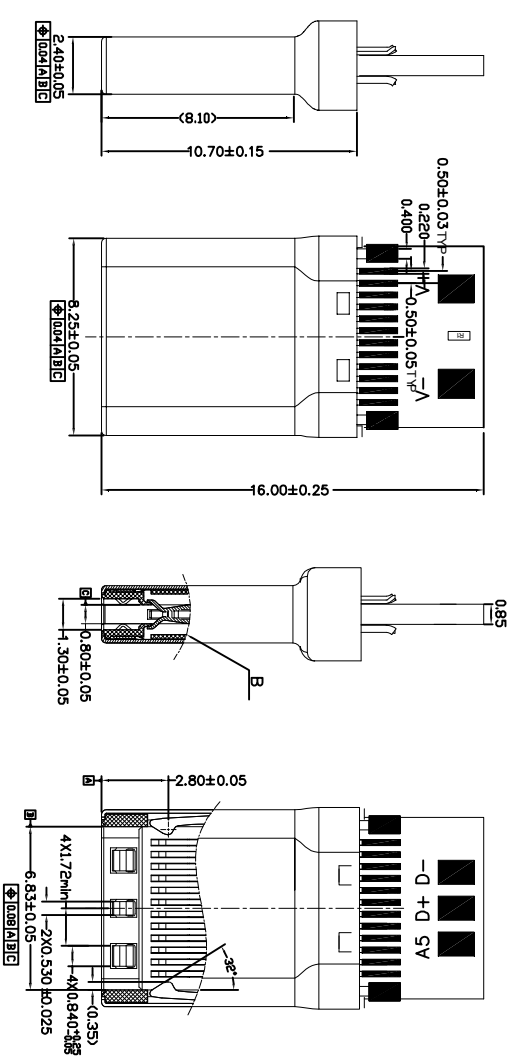
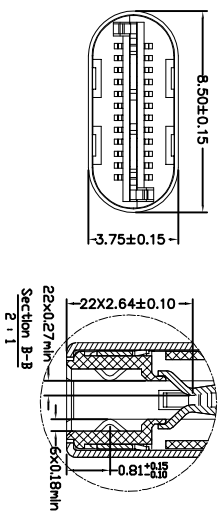


# ROHS 客户图

目錄 MAPX	變更內容 MODIFICATION	日期 DATE
A0	NEW	09-10-20



6	LATCH	STAINLESS	: Ni: 50u"
5	CONTACT	COPPER ALLOY	Contact area: 5u", Solder tails: Tin80u", Ni: 30~80u"
4	molding 2	L.C.P	(Black)
3	GNDSPRING	STAINLESS	
2	Molding	L.C.P	(Black)
1	SHELL	STAINLESS	Ni: 50u"

产品图  
PRODUCT CHART DWG

深圳市鑫风雷电子有限公司

公差一览表 TOLERANCE UNLESS OTHERWISE		单位 UNITS	MM
X	±0.30	X	±5°
X	±0.25	X	±2°
.XX	±0.20	.XX	±1°
.XXX	±0.15	.XXX	±0.5°

制图 DRAWING	王冠	产品料号 PRODUCT PART NO.	XFLY012-UCAM011-X
审核 CHECK	雷永健	产品名称 PRODUCT NO.	TYPE C公头拉伸壳第四代C-充电数据板
核准 APPR	雷永健	角法 VIEW	⊕
日期 DATE	2009/10/20	版本 VER	A0

Pin Number	host	device	Pin Number	host	device
Pin A1	GND		Pin B12	GND	GND
Pin A2	SSTx1	SSTx1	Pin B11	SSRp1	SSRp1
Pin A3	SSTx1	SSTx1	Pin B10	SSRk1	SSRk1
Pin A4	VBUS	VBUS	Pin B9	VBUS	VBUS
Pin A5	CCI	CCI	Pin B8	SBU2	SBU2
Pin A6	DP1	DP1	Pin B7		
Pin A7	DN1		Pin B6		
Pin A8	SBU1	SBU1	Pin B5	CC2	CC2
Pin A9	VBUS	VBUS	Pin B4	VBUS	VBUS
Pin A10	SSRk2	SSRk2	Pin B3	SSTx2	SSTx2
Pin A11	SSRp2	SSRp2	Pin B2	SSTx2	SSTx2
Pin A12	GND		Pin B1	GND	GND

- NOTES
- 1.MATERIAL: See drawing
  - 2.STANDARD DATA
  - 2.1.Rating current:5.0A for VBUS (i.e.,pins A4,A9,B4,B9), 1.25A for Vcom and GND (i.e.,pins B5,A11,B12); 0.25A for all the other contacts.
  - 3.ELECTRICAL
    - 3.1.insulator resistance: 100M ohms Min.
    - 3.2.Withstanding voltage: 100 VAC / minute
    - 3.3.Contact resistance: initial 40mohms Max. after 50mohms Max.
  - 4.MECHANICAL
    - 4.1.Mating force: 5~20N
    - 4.2.Umating force: 8~20N
    - 4.3.Durability: 10000 cycles Min.
    - 5.PACKING: 100pcs/tray (reference)